

TLE2426, TLE2426Y THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND

SLOS098D – AUGUST 1991 – REVISED MAY 1998

- 1/2 V_I Virtual Ground for Analog Systems
- Self-Contained 3-terminal TO-226AA Package
- Micropower Operation . . . 170 μA Typ, $V_I = 5\text{ V}$
- Wide V_I Range . . . 4 V to 40 V
- High Output-Current Capability
 - Source . . . 20 mA Typ
 - Sink . . . 20 mA Typ
- Excellent Output Regulation
 - $-45\ \mu\text{V}$ Typ at $I_O = 0$ to $-10\ \text{mA}$
 - $+15\ \mu\text{V}$ Typ at $I_O = 0$ to $+10\ \text{mA}$
- Low-Impedance Output . . . $0.0075\ \Omega$ Typ
- Noise Reduction Pin (D, JG, and P Packages Only)

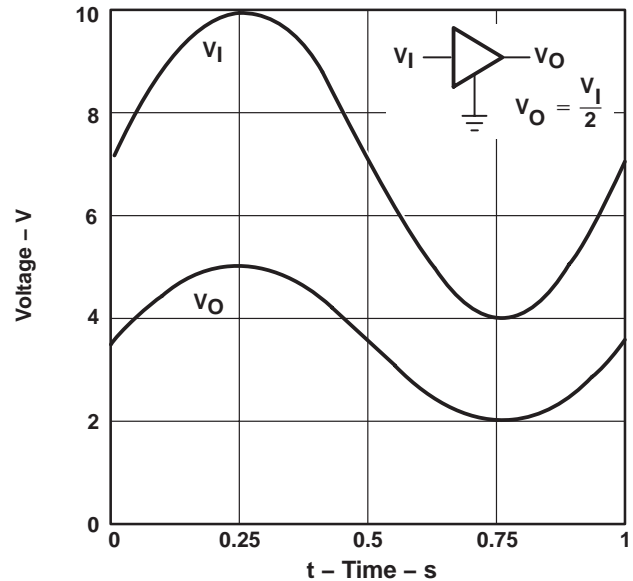
description

In signal-conditioning applications utilizing a single power source, a reference voltage equal to one-half the supply voltage is required for termination of all analog signal grounds. Texas Instruments presents a precision virtual ground whose output voltage is always equal to one-half the input voltage, the TLE2426 "rail splitter."

The unique combination of a high-performance, micropower operational amplifier and a precision-trimmed divider on a single silicon chip results in a precise V_O/V_I ratio of 0.5 while sinking and sourcing current. The TLE2426 provides a low-impedance output with 20 mA of sink and source capability while drawing less than 280 μA of supply current over the full input range of 4 V to 40 V. A designer need not pay the price in terms of board space for a conventional signal ground consisting of resistors, capacitors, operational amplifiers, and voltage references. The performance and precision of the TLE2426 is available in an easy-to-use, space saving, 3-terminal LP package. For increased performance, the optional 8-pin packages provide a noise-reduction pin. With the addition of an external capacitor (C_{NR}), peak-to-peak noise is reduced while line ripple rejection is improved.

Initial output tolerance for a single 5-V or 12-V system is better than 1% with 3.6% over the full 40-V input range. Ripple rejection exceeds 12 bits of accuracy. Whether the application is for a data acquisition front end, analog signal termination, or simply a precision voltage reference, the TLE2426 eliminates a major source of system error.

INPUT/OUTPUT TRANSFER CHARACTERISTICS



AVAILABLE OPTIONS

PACKAGED DEVICES					CHIP FORM (Y)
T_A	SMALL OUTLINE (D)	CERAMIC DIP (JG)	PLASTIC (LP)	PLASTIC DIP (P)	
0°C to 70°C	TLE2426CD	—	TLE2426CLP	TLE2426CP	



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1998, Texas Instruments Incorporated

TLE2426, TLE2426Y THE "RAIL SPLITTER" PRECISION VIRTUAL GROUND

SLOS098D – AUGUST 1991 – REVISED MAY 1998

-40°C to 85°C	TLE2426ID	—	TLE2426ILP	TLE2426IP	TLE2426Y
-55°C to 125°C	TLE2426MD	TLE2426MJG	TLE2426MLP	TLE2426MP	

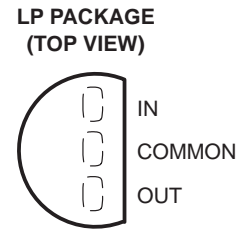
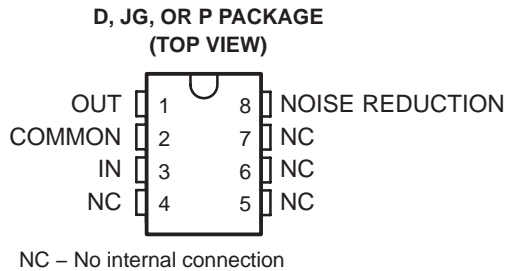
The D and LP packages are available taped and reeled in the commercial temperature range only. Add R suffix to the device type (e. g., TLC2426CDR). Chips are tested at 25°C.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

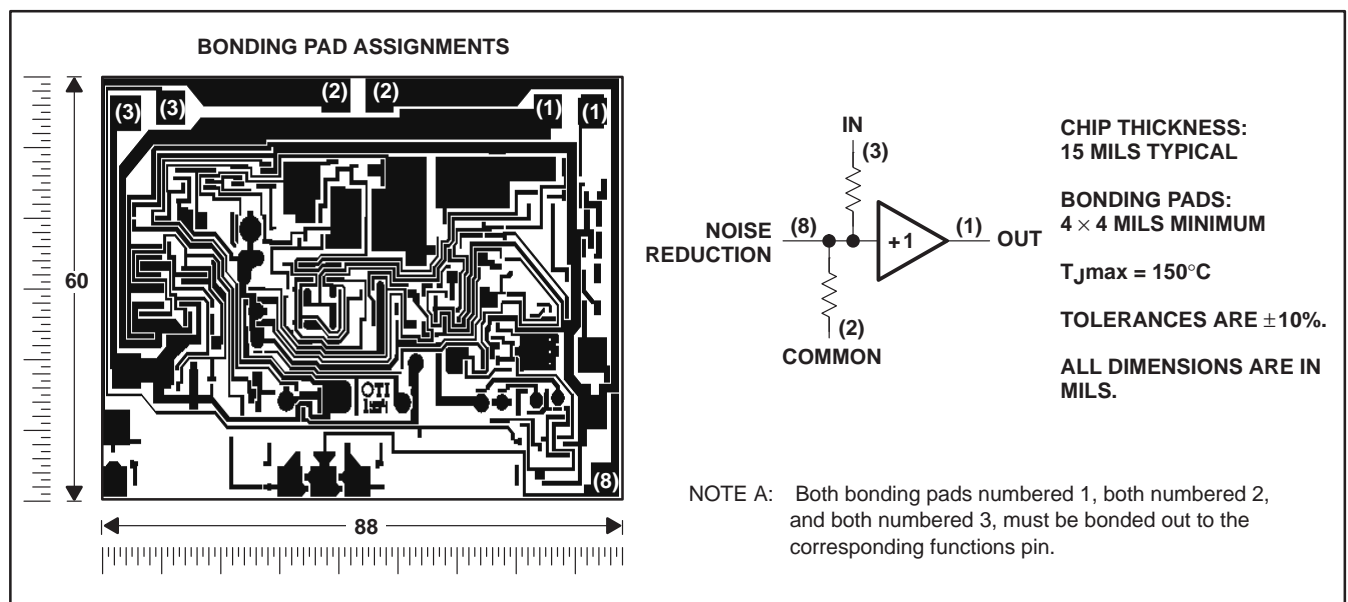
description (continued)

The C-suffix devices are characterized for operation from 0°C to 70°C. The I suffix devices are characterized for operation from -40°C to 85°C. The M suffix devices are characterized over the full military temperature range of -55°C to 125°C.



TLE2426Y chip information

This chip, properly assembled, displays characteristics similar to the TLE2426C. Thermal compression or ultrasonic bonding may be used on the doped aluminum bonding pads. The chips may be mounted with conductive epoxy or a gold-silicon preform.



electrical characteristics at specified free-air temperature, $V_I = 5\text{ V}$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T_A †	TLE2426C			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 4\text{ V}$		25°C	1.98	2	2.02	V
	$V_I = 5\text{ V}$			2.48	2.5	2.52	
	$V_I = 40\text{ V}$			19.8	20	20.2	
	$V_I = 5\text{ V}$		Full range	2.475		2.525	
Temperature coefficient of output voltage			Full range	25		ppm/°C	
Supply current	No load	$V_I = 5\text{ V}$	25°C	170	300	µA	
		$V_I = 4\text{ to }40\text{ V}$	Full range	400			
Output voltage regulation (sourcing current)‡	$I_O = 0\text{ to }-10\text{ mA}$		25°C	-45	±160	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }-20\text{ mA}$		25°C	-150	±450	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }10\text{ mA}$		25°C	15	±160	µV	
			Full range	±250			
Output impedance			25°C	7.5	22.5	mΩ	
Noise-reduction impedance			25°C	110		kΩ	
Short-circuit current	Sinking current, $V_O = 5\text{ V}$		25°C	26		mA	
	Sourcing current, $V_O = 0$			-47			
Output noise voltage, rms	$f = 10\text{ Hz to }10\text{ kHz}$	$C_{NR} = 0$	25°C	120		µV	
		$C_{NR} = 1\text{ µF}$		30			
Output voltage current step response	$V_O\text{ to }0.1\%, I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	290		µs	
		$C_L = 100\text{ pF}$		275			
	$V_O\text{ to }0.01\%, I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	400			
		$C_L = 100\text{ pF}$		390			
Step response	$V_I = 0\text{ to }5\text{ V}, V_O\text{ to }0.1\%$		25°C	20		µs	
	$V_I = 0\text{ to }5\text{ V}, V_O\text{ to }0.01\%$			160			

† Full range is 0°C to 70°C.

‡ The listed values are not production tested.

TLE2426, TLE2426Y
THE “RAIL SPLITTER”
PRECISION VIRTUAL GROUND

SLOS098D – AUGUST 1991 – REVISED MAY 1998

electrical characteristics at specified free-air temperature, $V_I = 12\text{ V}$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T_A †	TLE2426C			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 4\text{ V}$		25°C	1.98	2	2.02	V
	$V_I = 12\text{ V}$			5.95	6	6.05	
	$V_I = 40\text{ V}$			19.8	20	20.2	
	$V_I = 12\text{ V}$		Full range	5.945		6.055	
Temperature coefficient of output voltage			Full range	35		ppm/°C	
Supply current	No load	$V_I = 12\text{ V}$	25°C	195	300	μA	
		$V_I = 4\text{ to }40\text{ V}$	Full range	400			
Output voltage regulation (sourcing current)‡	$I_O = 0\text{ to }-10\text{ mA}$		25°C	-45	±160	μV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }-20\text{ mA}$		25°C	-150	±450	μV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }10\text{ mA}$		25°C	15	±160	μV	
			Full range	±250			
Output impedance			25°C	7.5	22.5	mΩ	
Noise-reduction impedance			25°C	110		kΩ	
Short-circuit current	Sinking current, $V_O = 12\text{ V}$		25°C	31		mA	
	Sourcing current, $V_O = 0$			-70			
Output noise voltage, rms	$f = 10\text{ Hz to }10\text{ kHz}$	$C_{NR} = 0$	25°C	120		μV	
		$C_{NR} = 1\text{ μF}$		30			
Output voltage current step response	$V_O\text{ to }0.1\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	290		μs	
		$C_L = 100\text{ pF}$		275			
	$V_O\text{ to }0.01\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	400			
		$C_L = 100\text{ pF}$		390			
Step response	$V_I = 0\text{ to }12\text{ V}$, $V_O\text{ to }0.1\%$		25°C	20		μs	
	$V_I = 0\text{ to }12\text{ V}$, $V_O\text{ to }0.01\%$			120			

† Full range is 0°C to 70°C.

‡ The listed values are not production tested.



electrical characteristics at specified free-air temperature, $V_I = 5\text{ V}$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T_A †	TLE2426I			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 4\text{ V}$		25°C	1.98	2	2.02	V
	$V_I = 5\text{ V}$			2.48	2.5	2.52	
	$V_I = 40\text{ V}$			19.8	20	20.2	
	$V_I = 5\text{ V}$		Full range	2.47		2.53	
Temperature coefficient of output voltage			Full range	25		ppm/°C	
Supply current	No load	$V_I = 5\text{ V}$	25°C	170	300	µA	
		$V_I = 4\text{ to }40\text{ V}$	Full range	400			
Output voltage regulation (sourcing current)‡	$I_O = 0\text{ to }-10\text{ mA}$		25°C	-45	±160	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }-20\text{ mA}$		25°C	-150	±450	µV	
	$I_O = 0\text{ to }10\text{ mA}$		25°C	15	±160		
	$I_O = 0\text{ to }8\text{ mA}$		Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }20\text{ mA}$		25°C	65	±235	µV	
			Full range	±250			
Output impedance			25°C	7.5	22.5	mΩ	
Noise-reduction impedance			25°C	110		kΩ	
Short-circuit current	Sinking current,	$V_O = 5\text{ V}$	25°C	26		mA	
	Sourcing current,	$V_O = 0$		-47			
Output noise voltage, rms	$f = 10\text{ Hz to }10\text{ kHz}$	$C_{NR} = 0$	25°C	120		µV	
		$C_{NR} = 1\text{ µF}$		30			
Output voltage current step response	$V_O\text{ to }0.1\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	290		µs	
		$C_L = 100\text{ pF}$		275			
	$V_O\text{ to }0.01\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	400			
		$C_L = 100\text{ pF}$		390			
Step response	$V_I = 0\text{ to }5\text{ V}$, $V_O\text{ to }0.1\%$		25°C	20		µs	
	$V_I = 0\text{ to }5\text{ V}$, $V_O\text{ to }0.01\%$			160			

† Full range is -40°C to 85°C.

‡ The listed values are not production tested.

TLE2426, TLE2426Y
THE “RAIL SPLITTER”
PRECISION VIRTUAL GROUND

SLOS098D – AUGUST 1991 – REVISED MAY 1998

electrical characteristics at specified free-air temperature, $V_I = 12\text{ V}$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T_A †	TLE2426I			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 4\text{ V}$		25°C	1.98	2	2.02	V
	$V_I = 12\text{ V}$			5.95	6	6.05	
	$V_I = 40\text{ V}$			19.8	20	20.2	
	$V_I = 12\text{ V}$		Full range	5.935		6.065	
Temperature coefficient of output voltage			Full range	35		ppm/°C	
Supply current	No load	$V_I = 12\text{ V}$	25°C	195	300	µA	
		$V_I = 4\text{ to }40\text{ V}$	Full range	400			
Output voltage regulation (sourcing current)‡	$I_O = 0\text{ to }-10\text{ mA}$		25°C	-45	±160	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }-20\text{ mA}$		25°C	-150	±450	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }10\text{ mA}$		25°C	15	±160	µV	
	$I_O = 0\text{ to }8\text{ mA}$		Full range	±250			
	$I_O = 0\text{ to }20\text{ mA}$		25°C	65	±235		
Output impedance			25°C	7.5	22.5	mΩ	
Noise-reduction impedance			25°C	110		kΩ	
Short-circuit current	Sinking current, $V_O = 12\text{ V}$		25°C	31		mA	
	Sourcing current, $V_O = 0$			-70			
Output noise voltage, rms	$f = 10\text{ Hz to }10\text{ kHz}$	$C_{NR} = 0$	25°C	120		µV	
		$C_{NR} = 1\text{ µF}$		30			
Output voltage current step response	$V_O\text{ to }0.1\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	290		µs	
		$C_L = 100\text{ pF}$		275			
	$V_O\text{ to }0.01\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	400			
		$C_L = 100\text{ pF}$		390			
Step response	$V_I = 0\text{ to }12\text{ V}$, $V_O\text{ to }0.1\%$		25°C	20		µs	
	$V_I = 0\text{ to }12\text{ V}$, $V_O\text{ to }0.01\%$			120			

† Full range is -40°C to 85°C.

‡ The listed values are not production tested.



electrical characteristics at specified free-air temperature, $V_I = 5\text{ V}$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T_A †	TLE2426M			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 4\text{ V}$		25°C	1.98	2	2.02	V
	$V_I = 5\text{ V}$			2.48	2.5	2.52	
	$V_I = 40\text{ V}$			19.8	20	20.2	
	$V_I = 5\text{ V}$		Full range	2.465 2.535			
Temperature coefficient of output voltage			Full range	25		ppm/°C	
Supply current	No load	$V_I = 5\text{ V}$	25°C	170	300	µA	
		$V_I = 4\text{ to }40\text{ V}$	Full range	400			
Output voltage regulation (sourcing current)‡	$I_O = 0\text{ to }-10\text{ mA}$		25°C	-45	±160	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }-20\text{ mA}$		25°C	-150	±450	µV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }10\text{ mA}$		25°C	15	±160	µV	
	$I_O = 0\text{ to }3\text{ mA}$		Full range	±250			
	$I_O = 0\text{ to }20\text{ mA}$		25°C	65	±235		
Output impedance			25°C	7.5	22.5	mΩ	
Noise-reduction impedance			25°C	110		kΩ	
Short-circuit current	Sinking current, $V_O = 5\text{ V}$		25°C	26		mA	
	Sourcing current, $V_O = 0$			-47			
Output noise voltage, rms	$f = 10\text{ Hz to }10\text{ kHz}$	$C_{NR} = 0$	25°C	120		µV	
		$C_{NR} = 1\text{ µF}$		30			
Output voltage current step response	$V_O\text{ to }0.1\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	290		µs	
		$C_L = 100\text{ pF}$		275			
	$V_O\text{ to }0.01\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	400			
		$C_L = 100\text{ pF}$		390			
Step response	$V_I = 0\text{ to }5\text{ V}$, $V_O\text{ to }0.1\%$		25°C	20		µs	
	$V_I = 0\text{ to }5\text{ V}$, $V_O\text{ to }0.01\%$			120			

† Full range is -55°C to 125°C.

‡ The listed values are not production tested.

TLE2426, TLE2426Y
THE “RAIL SPLITTER”
PRECISION VIRTUAL GROUND

SLOS098D – AUGUST 1991 – REVISED MAY 1998

electrical characteristics at specified free-air temperature, $V_I = 12\text{ V}$, $I_O = 0$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T_A †	TLE2426M			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 4\text{ V}$		25°C	1.98	2	2.02	V
	$V_I = 12\text{ V}$			5.95	6	6.05	
	$V_I = 40\text{ V}$			19.8	20	20.2	
	$V_I = 12\text{ V}$		Full range	5.925		6.075	
Temperature coefficient of output voltage			Full range	35		ppm/°C	
Supply current	No load	$V_I = 12\text{ V}$	25°C	195	250	μA	
		$V_I = 4\text{ to }40\text{ V}$	Full range	350			
Output voltage regulation (sourcing current)‡	$I_O = 0\text{ to }-10\text{ mA}$		25°C	-45	±160	μV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }-20\text{ mA}$		25°C	-150	±450	μV	
			Full range	±250			
Output voltage regulation (sinking current)‡	$I_O = 0\text{ to }10\text{ mA}$		25°C	15	±160	μV	
	$I_O = 0\text{ to }8\text{ mA}$		Full range	±250			
	$I_O = 0\text{ to }20\text{ mA}$		25°C	65	±235		
Output impedance			25°C	7.5	22.5	mΩ	
Noise-reduction impedance			25°C	110		kΩ	
Short-circuit current	Sinking current, $V_O = 12\text{ V}$		25°C	31		mA	
	Sourcing current, $V_O = 0$			-70			
Output noise voltage, rms	$f = 10\text{ Hz to }10\text{ kHz}$	$C_{NR} = 0$	25°C	120		μV	
		$C_{NR} = 1\text{ μF}$		30			
Output voltage current step response	$V_O\text{ to }0.1\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	290		μs	
		$C_L = 100\text{ pF}$		275			
	$V_O\text{ to }0.01\%$, $I_O = \pm 10\text{ mA}$	$C_L = 0$	25°C	400			
		$C_L = 100\text{ pF}$		390			
Step response	$V_I = 0\text{ to }12\text{ V}$, $V_O\text{ to }0.1\%$		25°C	12		μs	
	$V_I = 0\text{ to }12\text{ V}$, $V_O\text{ to }0.01\%$			120			

† Full range is -55°C to 125°C.

‡ The listed values are not production tested.



electrical characteristics at specified free-air temperature, $V_I = 5\text{ V}$, $I_O = 0$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TLE2426Y			UNIT
		MIN	TYP	MAX	
Output voltage	$V_I = 5\text{ V}$	2.5			V
Supply current	No load	170			μA
Output voltage regulation (sourcing current) [†]	$I_O = 0$ to -10 mA	-45			μV
	$I_O = 0$ to -20 mA	-150			
Output voltage regulation (sinking current) [†]	$I_O = 0$ to 10 mA	15			μV
	$I_O = 0$ to 20 mA	65			
Output impedance		7.5			$\text{m}\Omega$
Noise-reduction impedance		110			$\text{k}\Omega$
Short-circuit current	Sinking current, $V_O = 5\text{ V}$	26			mA
	Sourcing current, $V_O = 0$	-47			
Output noise voltage, rms	$f = 10\text{ Hz}$ to 10 kHz	$C_{NR} = 0$	120		μV
		$C_{NR} = 1\ \mu\text{F}$	30		
Output voltage current step response	V_O to 0.1%, $I_O = \pm 10\text{ mA}$	$C_L = 0$	290		μs
		$C_L = 100\text{ pF}$	275		
	V_O to 0.01%, $I_O = \pm 10\text{ mA}$	$C_L = 0$	400		
		$C_L = 100\text{ pF}$	390		
Step response	$V_I = 0$ to 5 V , V_O to 0.1%	$C_L = 100\text{ pF}$	20		μs
	$V_I = 0$ to 5 V , V_O to 0.01%		160		

[†] The listed values are not production tested.

electrical characteristics at specified free-air temperature, $V_I = 12\text{ V}$, $I_O = 0$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TLE2426Y			UNIT
		MIN	TYP	MAX	
Output voltage	$V_I = 12\text{ V}$	6			V
Supply current	No load	195			μA
Output voltage regulation (sourcing current) [†]	$I_O = 0$ to -10 mA	-45			μV
	$I_O = 0$ to -20 mA	-150			
Output voltage regulation (sinking current) [†]	$I_O = 0$ to 3 mA	15			μV
	$I_O = 0$ to 20 mA	65			
Output impedance		7.5			$\text{m}\Omega$
Noise-reduction impedance		110			$\text{k}\Omega$
Short-circuit current	Sinking current, $V_O = 12\text{ V}$	31			mA
	Sourcing current, $V_O = 0$	-70			
Output noise voltage, rms	$f = 10\text{ Hz}$ to 10 kHz	$C_{NR} = 0$	120		μV
		$C_{NR} = 1\ \mu\text{F}$	30		
Output voltage current, step response	V_O to 0.1%, $I_O = \pm 10\text{ mA}$	$C_L = 0$	290		μs
		$C_L = 100\text{ pF}$	275		
	V_O to 0.01%, $I_O = \pm 10\text{ mA}$	$C_L = 0$	400		
		$C_L = 100\text{ pF}$	390		
Step response	$V_I = 0$ to 12 V , V_O to 0.1%	$C_L = 100\text{ pF}$	12		μs
	$V_I = 0$ to 12 V , V_O to 0.01%		120		

[†] The listed values are not production tested.

TYPICAL CHARACTERISTICS

Table Of Graphs

		FIGURE
Output voltage	Distribution	1,2
Output voltage change	vs Free-air temperature	3
Output voltage error	vs Input voltage	4
Input bias current	vs Input voltage	5
	vs Free-air temperature	6
Output voltage regulation	vs Output current	7
Output impedance	vs Frequency	8
Short-circuit output current	vs Input voltage	9,10
	vs Free-air temperature	11,12
Ripple rejection	vs Frequency	13
Spectral noise voltage density	vs Frequency	14
Output voltage response to output current step	vs Time	15
Output voltage power-up response	vs Time	16
Output current	vs Load capacitance	17

TYPICAL CHARACTERISTICS†

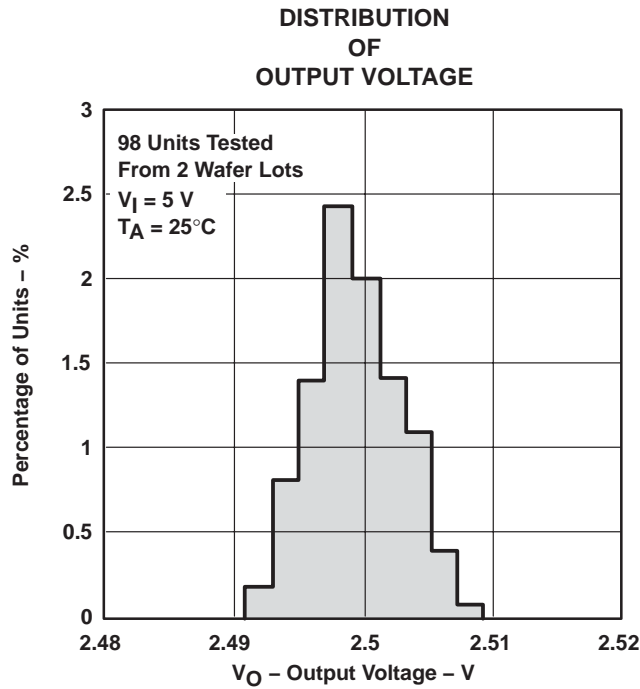


Figure 1

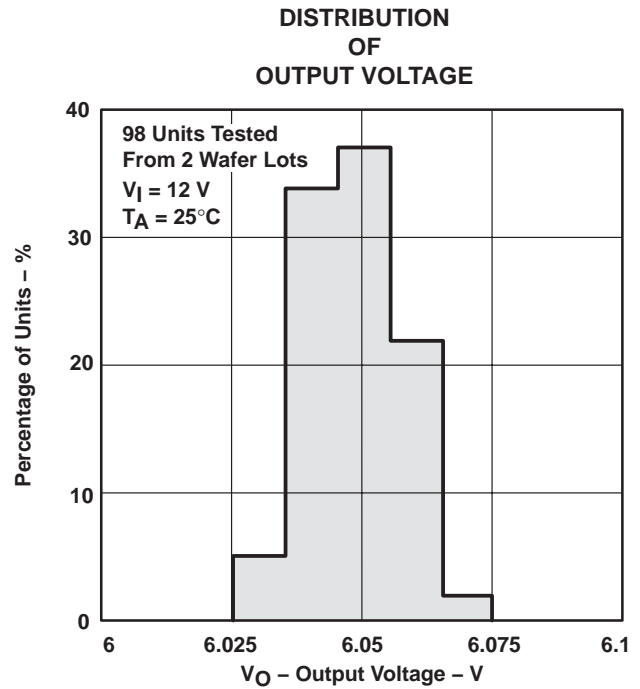


Figure 2

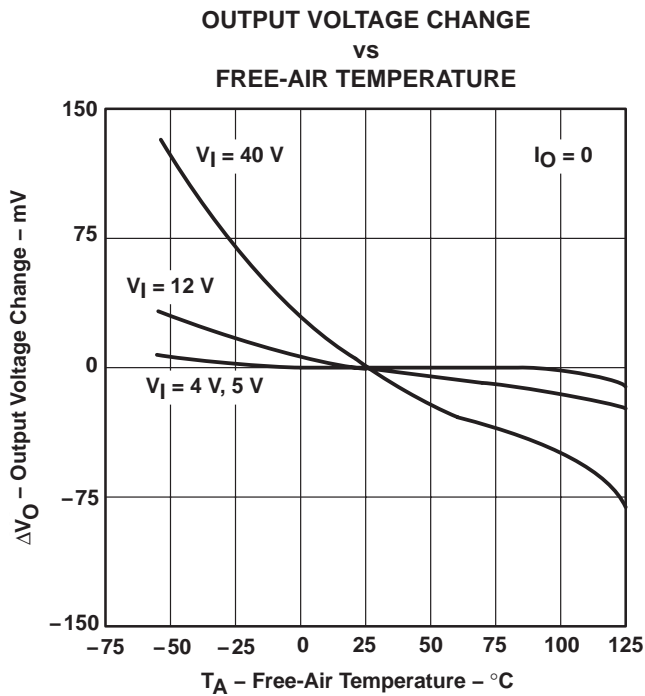


Figure 3

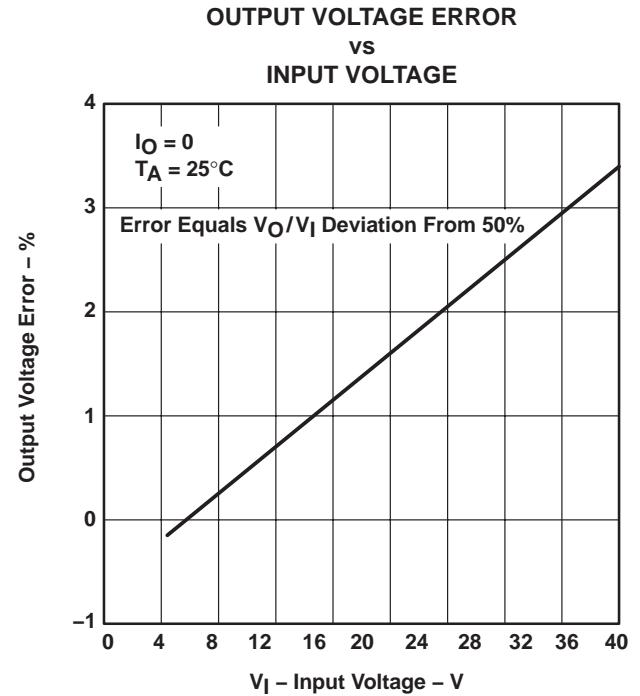


Figure 4

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†

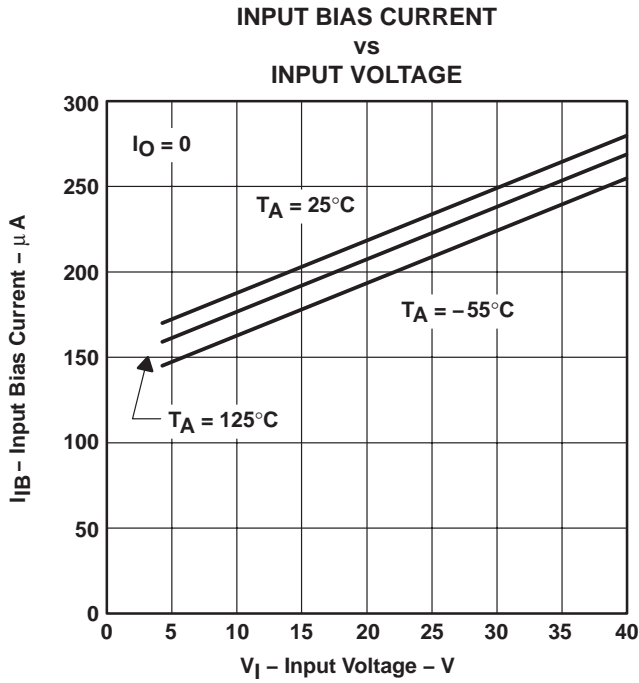


Figure 5

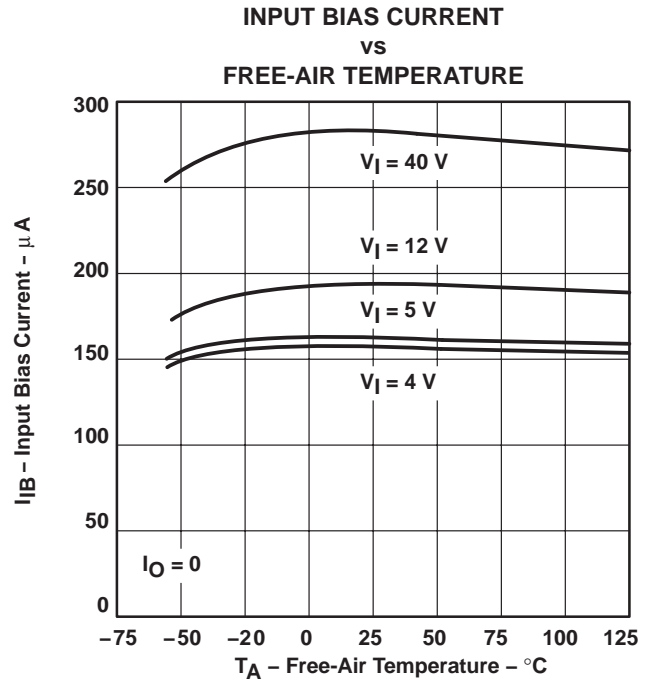


Figure 6

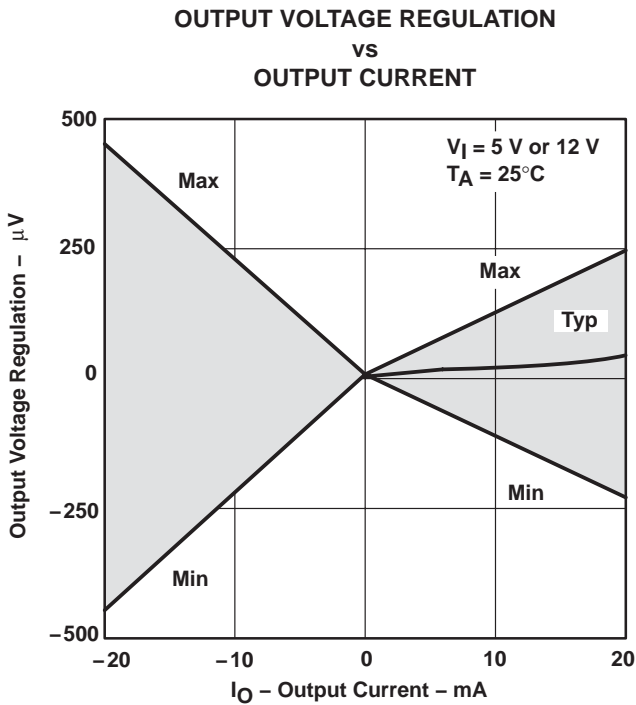


Figure 7

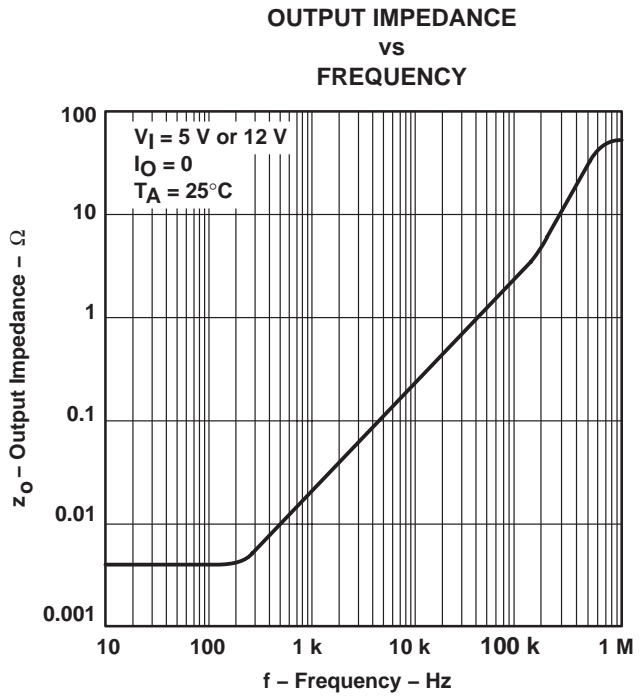


Figure 8

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS†

SHORT-CIRCUIT OUTPUT CURRENT
 vs
 INPUT VOLTAGE

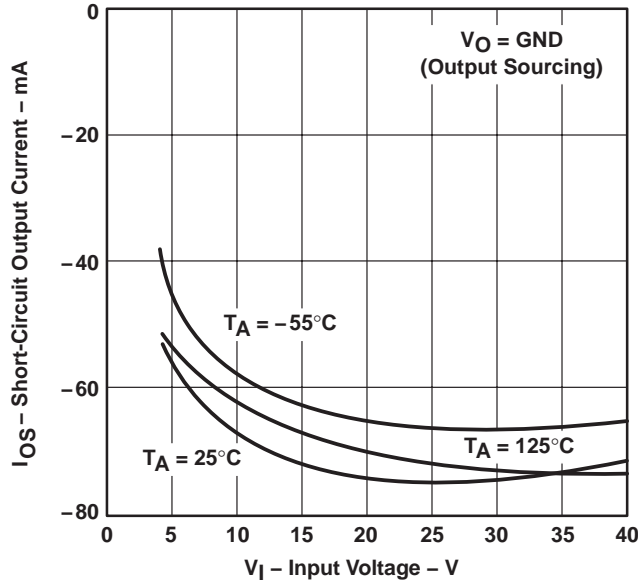


Figure 9

SHORT-CIRCUIT OUTPUT CURRENT
 vs
 INPUT VOLTAGE

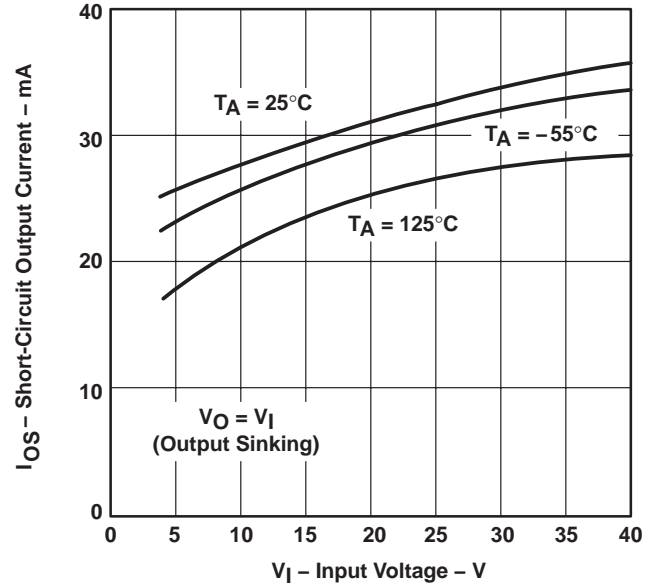


Figure 10

SHORT-CIRCUIT OUTPUT CURRENT
 vs
 FREE-AIR TEMPERATURE

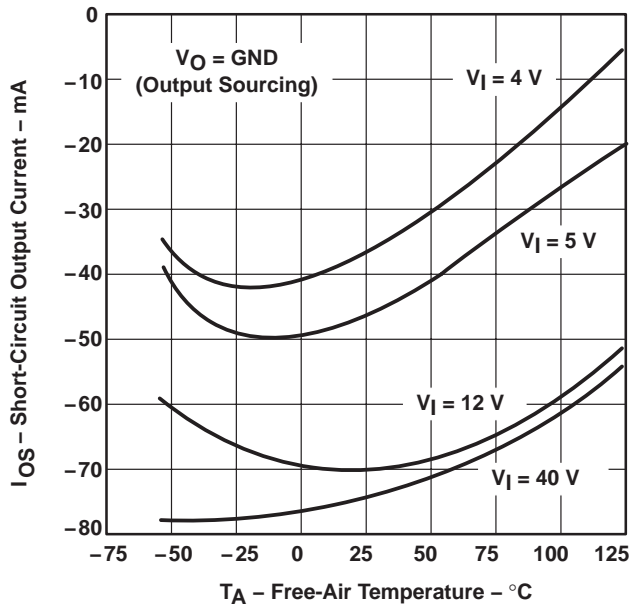


Figure 11

SHORT-CIRCUIT OUTPUT CURRENT
 vs
 FREE-AIR TEMPERATURE

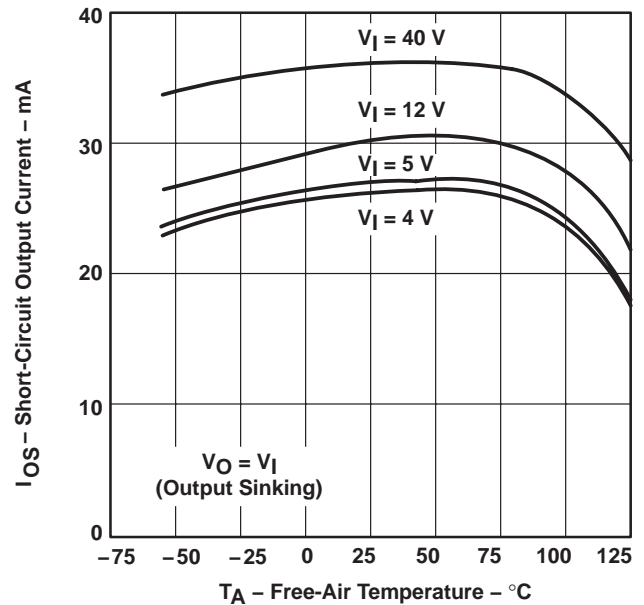


Figure 12

† Data at high and low temperatures are applicable within the rated operating free-air temperature ranges of the various devices.

TLE2426, TLE2426Y
THE "RAIL SPLITTER"
PRECISION VIRTUAL GROUND

SLOS098D – AUGUST 1991 – REVISED MAY 1998

TYPICAL CHARACTERISTICS

**RIPPLE REJECTION
 vs
 FREQUENCY**

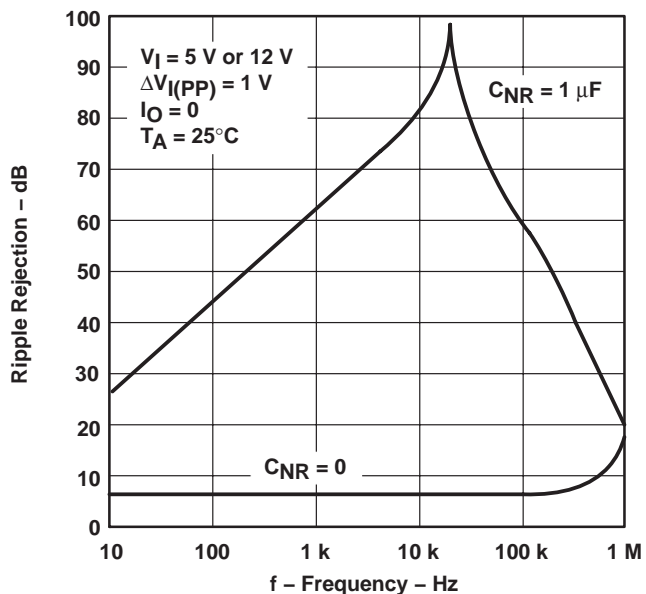


Figure 13

**SPECTRAL NOISE VOLTAGE DENSITY
 vs
 FREQUENCY**

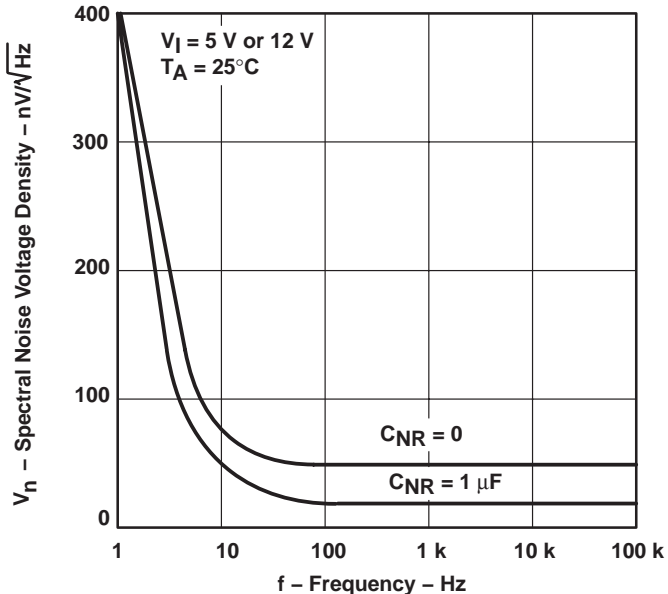


Figure 14

**OUTPUT VOLTAGE RESPONSE
 TO OUTPUT CURRENT STEP**

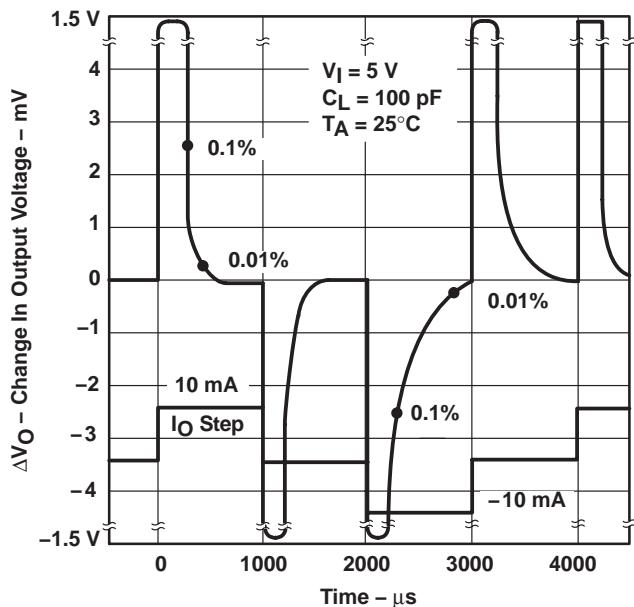


Figure 15

OUTPUT VOLTAGE POWER-UP RESPONSE

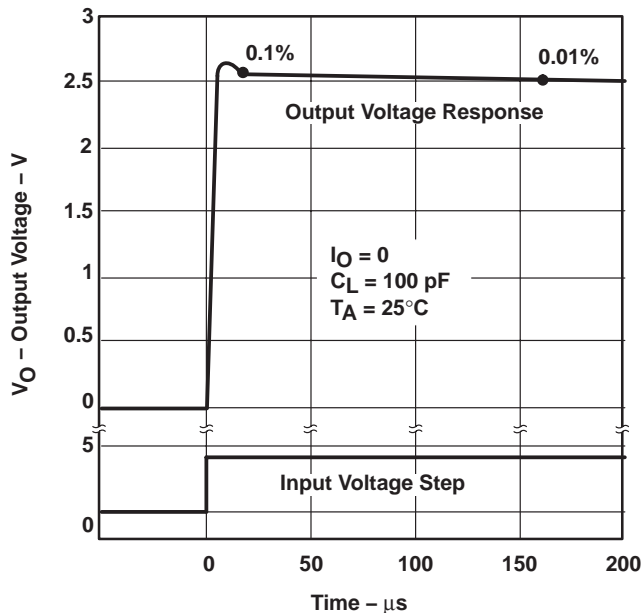


Figure 16



TYPICAL CHARACTERISTICS

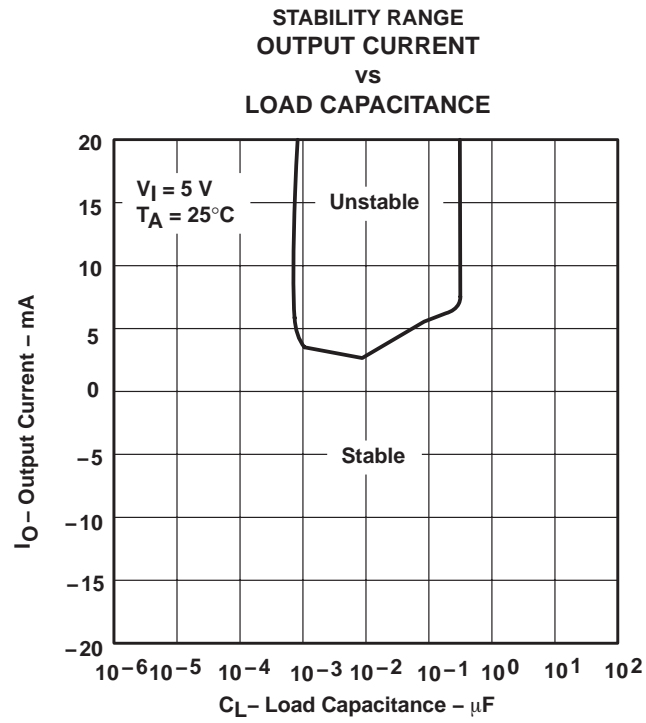


Figure 17

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLE2426CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426C	Samples
TLE2426CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426C	Samples
TLE2426CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426C	Samples
TLE2426CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426C	Samples
TLE2426CLP	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type		2426C	Samples
TLE2426CLPE3	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type		2426C	Samples
TLE2426CLPR	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type		2426C	Samples
TLE2426CP	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		TLE2426CP	Samples
TLE2426ID	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426I	Samples
TLE2426IDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426I	Samples
TLE2426IDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426I	Samples
TLE2426IDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		2426I	Samples
TLE2426ILP	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type		2426I	Samples
TLE2426ILPR	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type		2426I	Samples
TLE2426IP	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		TLE2426IP	Samples
TLE2426IPE4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type		TLE2426IP	Samples
TLE2426MD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	2426M	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TLE2426MDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	2426M	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TLE2426 :

- Automotive: [TLE2426-Q1](#)

- Enhanced Product: [TLE2426-EP](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLE2426CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TLE2426IDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLE2426CDR	SOIC	D	8	2500	367.0	367.0	38.0
TLE2426IDR	SOIC	D	8	2500	367.0	367.0	38.0

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

GENERIC PACKAGE VIEW

LP 3

TO-92 - 5.34 mm max height

TRANSISTOR OUTLINE



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4040001-2/F

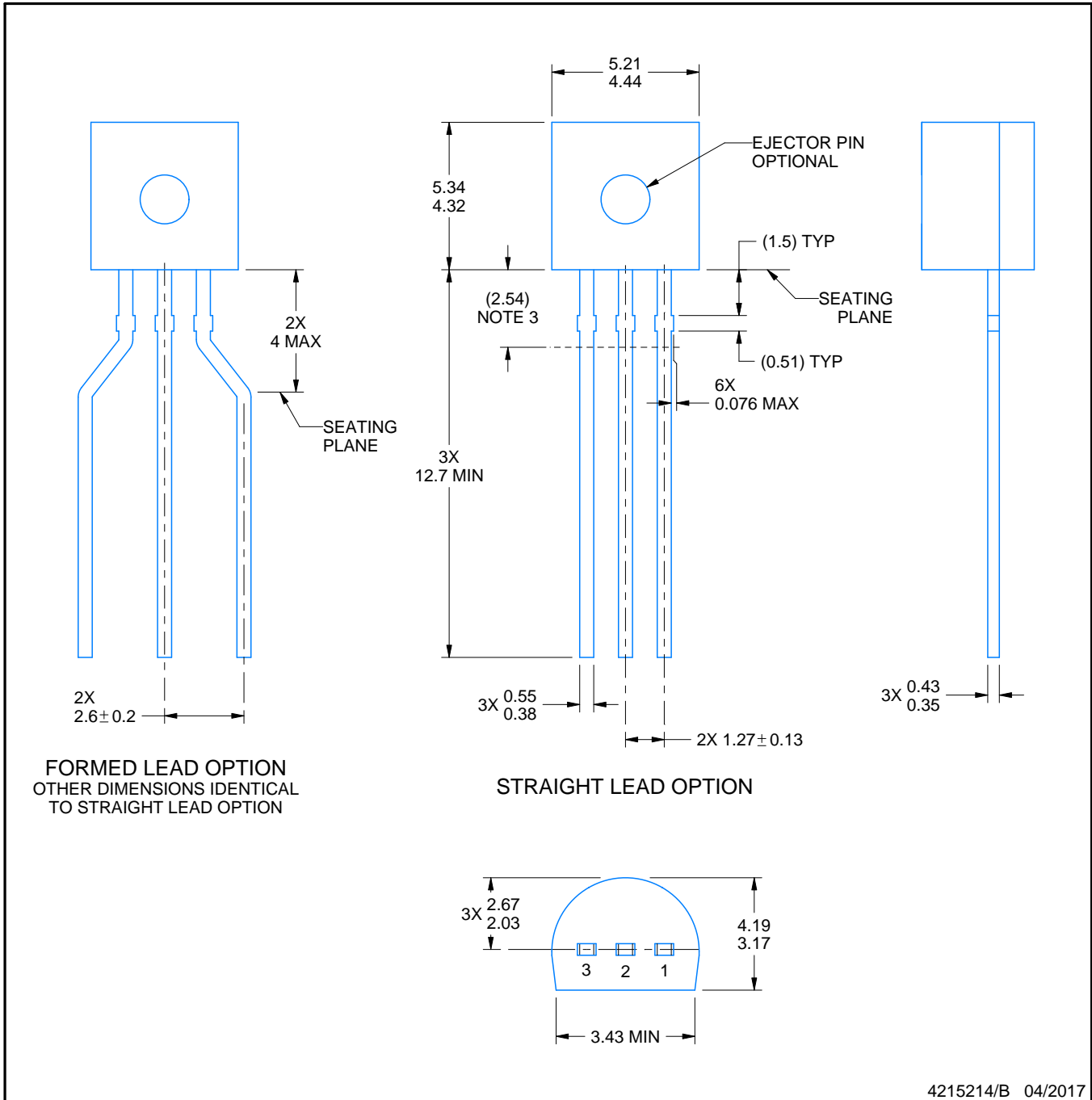
LP0003A



PACKAGE OUTLINE

TO-92 - 5.34 mm max height

TO-92



4215214/B 04/2017

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Lead dimensions are not controlled within this area.
4. Reference JEDEC TO-226, variation AA.
5. Shipping method:
 - a. Straight lead option available in bulk pack only.
 - b. Formed lead option available in tape and reel or ammo pack.
 - c. Specific products can be offered in limited combinations of shipping medium and lead options.
 - d. Consult product folder for more information on available options.

EXAMPLE BOARD LAYOUT

LP0003A

TO-92 - 5.34 mm max height

TO-92



LAND PATTERN EXAMPLE
STRAIGHT LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X



LAND PATTERN EXAMPLE
FORMED LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X

4215214/B 04/2017

TAPE SPECIFICATIONS

LP0003A

TO-92 - 5.34 mm max height

TO-92



FOR FORMED LEAD OPTION PACKAGE

4215214/B 04/2017

IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.